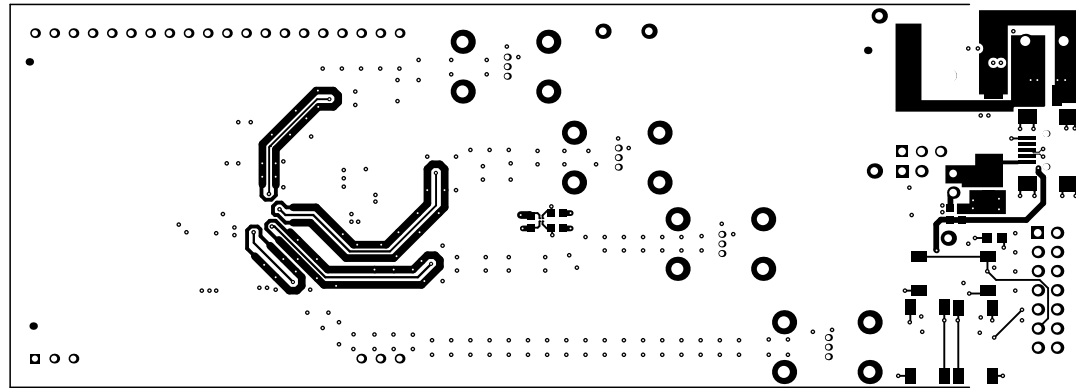
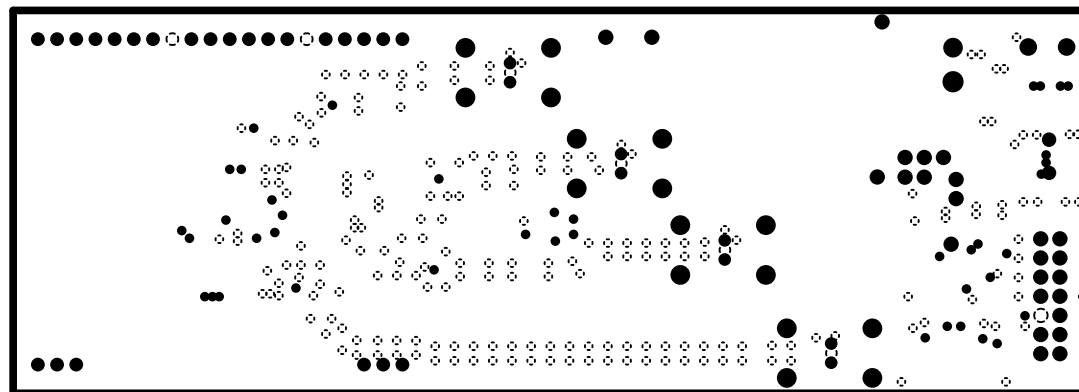


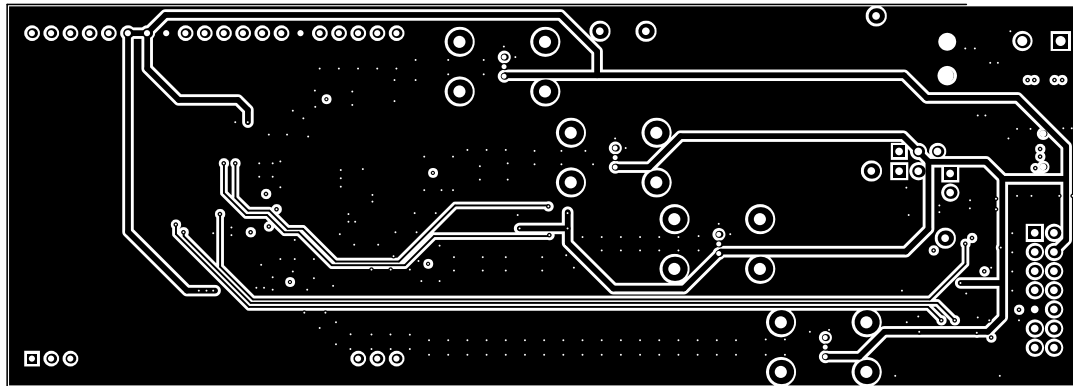
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4016	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 9/3/2014 12:44:04 PM	TEXAS INSTRUMENTS	



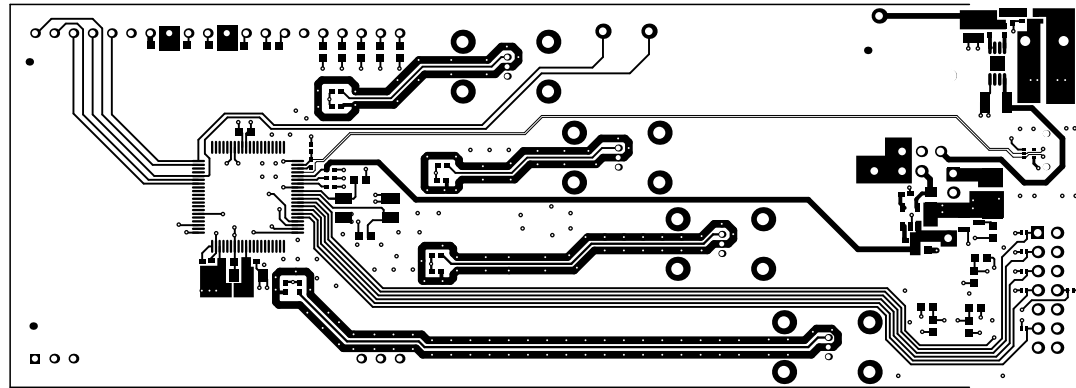
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4016	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 9/3/2014 12:44:05 PM	TEXAS INSTRUMENTS	



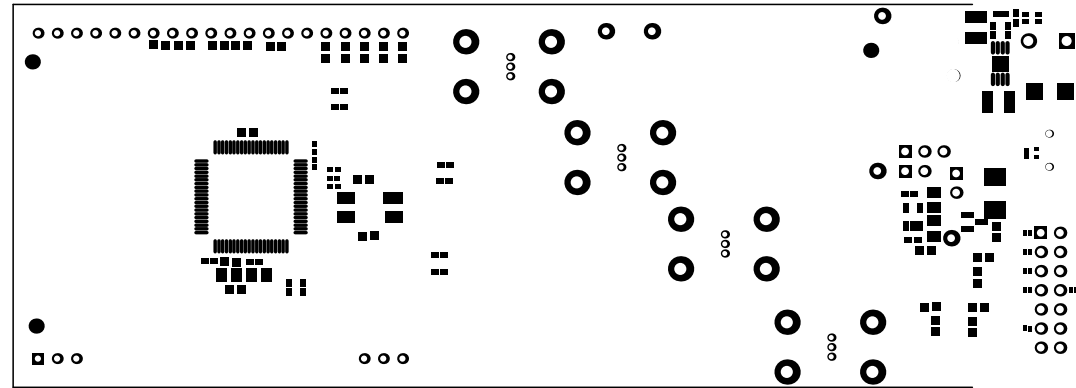
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4016	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = InternalPlane1			
PLOT NAME = InternalPlane 1	GENERATED : 9/3/2014 12:44:05 PM	TEXAS INSTRUMENTS	



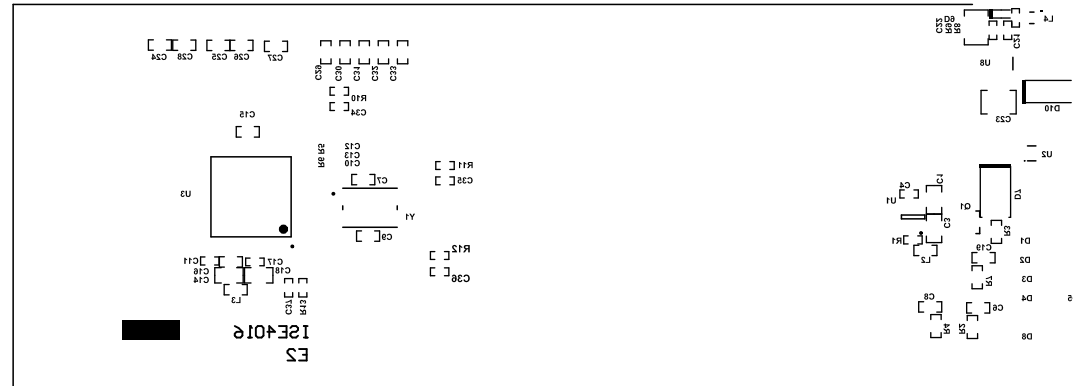
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4016	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = MidLayer2			
PLOT NAME = MidLayer 2	GENERATED : 9/3/2014 12:44:06 PM	TEXAS INSTRUMENTS	



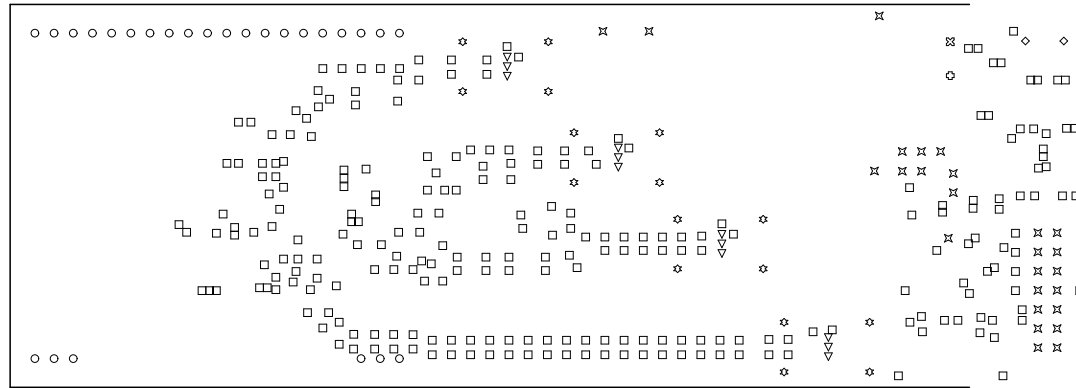
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4016	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 9/3/2014 12:44:06 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4016	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 9/3/2014 12:44:07 PM	TEXAS INSTRUMENTS	

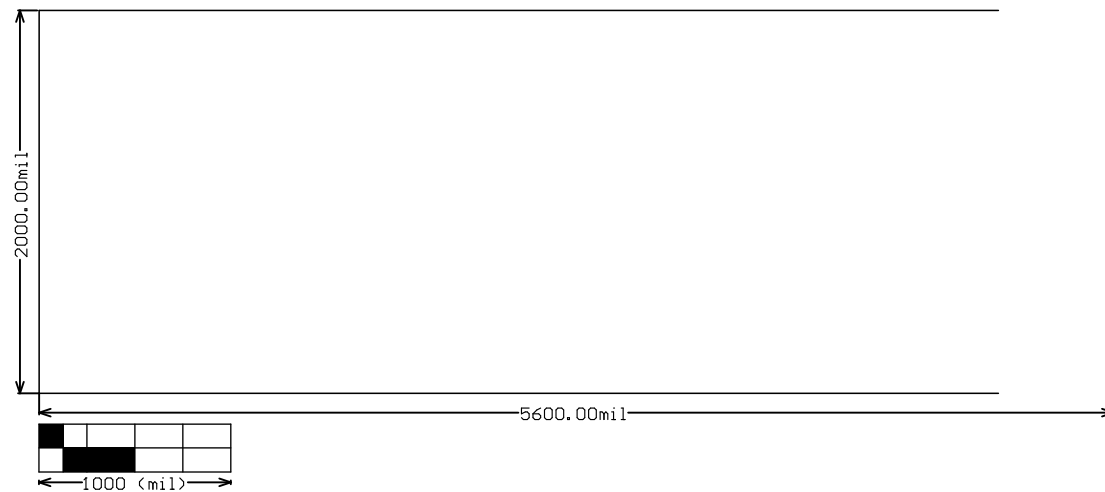


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4016	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 9/3/2014 12:44:08 PM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
□	250	10mil (0.254mm)	PTH	Round
▽	12	25.984mil (0.66mm)	PTH	Round
○	26	31.496mil (0.8mm)	PTH	Round
□	2	35.433mil (0.9mm)	NPTH	Round
*	26	40mil (1.016mm)	PTH	Round
◇	2	51.181mil (1.3mm)	PTH	Round
*	16	62.992mil (1.6mm)	PTH	Round
⊗	1	62.992mil (1.6mm)	NPTH	Round
⊙	1	70.866mil (1.8mm)	NPTH	Round
336 Total				

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4016	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 9/3/2014 12:44:08 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4016	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 9/3/2014 12:44:09 PM	TEXAS INSTRUMENTS	

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